### Overview

### **HP Z2 Mini G5 Workstation**



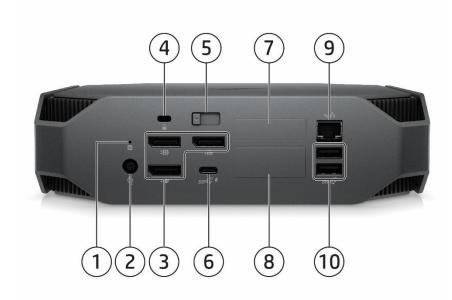


#### Front-Side View

- 1. Power button
- 2. 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 supports charging)
- 3. 1 Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port (charging supported)
- 4. Universal audio jack



### Overview



#### **Rear View**

- 1. HDD Activity LED
- 2. Power connector
- 2 DisplayPort™ 1.4³
   1 DisplayPort™ (optional)¹,³
- 4. Standard cable lock slot
- 5. Cover release latch
- 6. 1 Type-C<sup>®</sup> SuperSpeed USB 10Gbps signaling rate port (charging supported) (optional)<sup>2</sup>
- Flex IO modules, choice of: Dual Type-A SuperSpeed USB 5Gbps signaling rate port, serial port<sup>2</sup>
- 8. Flex IO modules, choice of: VGA, HDMI 2.0b, DisplayPort™ 1.4³, Dual Type-A SuperSpeed USB 5Gbps signaling rate port, serial port, 2nd 1GbE LAN, Type-C® SuperSpeed USB 10Gbps signaling rate port (Alt Mode), Thunderbolt™ 3, 2.5GbE LAN²
- 9. RJ-45
- 10. 2 Type-A SuperSpeed USB 10Gbps signaling rate port

<sup>&</sup>lt;sup>1</sup>Available only when a discrete graphic card is installed.

<sup>&</sup>lt;sup>2</sup>Available on selected configurations only.

<sup>&</sup>lt;sup>3</sup>All DisplayPort™ support DP1.4/HBR2 when video output is via Intel Graphics.

#### Overview

# Form Factor Operating Systems

Mini

#### Preinstalled:

- Windows 10 Pro 64<sup>1</sup>
- Windows 10 Pro 64 High End<sup>1</sup>
- Windows 10 Pro 64 Workstation Plus<sup>1</sup>
- Windows 10 Home 64 Plus<sup>1</sup>
- Windows 10 Home 64 Advanced<sup>11</sup>
- Linux-ready<sup>2</sup>

<sup>1</sup>Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply, and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>

**NOTE:** In accordance with Microsoft's support policy, HP does not support the Windows® 7 operating system on products configured with Intel® 7th Generation and forward processors.

#### **Processors\***

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Intel® Turbo Boost Technology²	Featuring Intel® vPro™ Technology³	16GB Intel® Optane™ memory	TDP (W)
Intel® Core™ i9-10900K Processor <sup>5</sup>	10	3.7	20	2933	Y	Intel® UHD Graphics 630	5.2	Y	Υ	125
Intel® Core™ i9-10900 Processor	10	2.8	20	2933	Υ	Intel® UHD Graphics 630	5.1	Y	Υ	65
Intel® Core™ i9-10900F Processor <sup>4</sup>	10	2.8	20	2933	Υ	N/A	5.1	N/A	Υ	65
Intel® Core™ i7-10700K Processor <sup>5</sup>	8	3.8	16	2933	Υ	Intel® UHD Graphics 630	5.1	Υ	Υ	125
Intel® Core™ i7-10700 processor	8	2.9	16	2933	Υ	Intel® UHD Graphics 630	4.8	Y	Υ	65
Intel® Core™ i5-10600K processor <sup>5</sup>	6	4.1	12	2666	Υ	Intel® UHD Graphics 630	4.8	Y	Υ	125
Intel® Core™ i5-10600 processor	6	3.3	12	2666	Υ	Intel® UHD Graphics 630	4.8	Y	Υ	65
Intel® Core™ i5-10500 processor	6	3.1	12	2666	Υ	Intel® UHD Graphics 630	4.5	Y	Υ	65
Intel® Core™ i5-10400 processor	6	2.9	12	2666	Υ	Intel® UHD Graphics 630	4.3	N/A	Υ	65
Intel® Core™ i5-10400F Processor <sup>4</sup>	6	2.9	12	2666	Υ	N/A	4.3	N/A	Υ	65
Intel® Core™ i3-10320 processor <sup>4</sup>	4	3.8	8	2666	Υ	Intel® UHD Graphics 630	4.6	N/A	Υ	65
Intel® Core™ i3-10300 processor <sup>4</sup>	4	3.7	8	2666	Υ	Intel® UHD Graphics 630	4.4	N/A	Υ	65
Intel® Core™ i3-10100 processor	4	3.60	6	2666	Υ	Intel® UHD Graphics 630	4.3	N/A	Υ	65
Intel® Xeon® W-1290P processor <sup>5</sup>	10	3.7	20	2933	Υ	Intel® UHD Graphics P630	5.2	Y	Y	125



<sup>&</sup>lt;sup>2</sup> For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux\_hardware\_matrix

#### Overview

Intel® Xeon® W-1290 processor <sup>4</sup>	10	3.2	20	2933	Υ	Intel® UHD Graphics P630	5.1	Υ	Y	80
Intel® Xeon® W-1270P processor <sup>4,5</sup>	8	3.8	16	2933	Υ	Intel® UHD Graphics P630	5.1	Υ	Υ	125
Intel® Xeon® W-1270 processor	8	3.4	16	2933	Υ	Intel® UHD Graphics P630	5.0	Υ	Y	80
Intel® Xeon® W-1250P processor <sup>5</sup>	6	4.1	12	2666	Υ	Intel® UHD Graphics P630	4.8	Υ	Y	125
Intel® Xeon® W-1250 processor	6	3.3	12	2666	Y	Intel® UHD Graphics P630	4.7	Υ	Y	80

<sup>1</sup>Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>2</sup>The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <a href="http://www.intel.com/technology/turboboost">http://www.intel.com/technology/turboboost</a> for more information.

<sup>3</sup> For full Intel® vPro<sup>™</sup> functionality, Windows, a vPro<sup>™</sup> supported processor, vPro<sup>™</sup> enabled Q370 chipset or higher and vPro<sup>™</sup> enabled WLAN card are required. Some functionality, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro<sup>™</sup> technology is dependent on 3rd party software providers. Compatibility of this generation of Intel vPro<sup>™</sup> technology-based hardware with future "virtual appliances" is yet to be determined.

<sup>4</sup>Available in Q4, 2020

5Configurable TDP-down 95W

**Convertibility** Z2 Mini G5 can either be placed on a flat surface or mounted behind a display or under a desk.

(Mounting sold separately)

Expansion Slots Custom PCIe Gen3 x16 for factory-integrated graphics module – if anything, should put JUST the M.2

(see system board section slot here since that is a true "expansion slot"

for more details)

Front I/O

Side I/O 2 Type-A SuperSpeed USB 10Gbps signaling rate port (upper port supports charging), 1 Type-C<sup>®</sup>

SuperSpeed USB 10Gbps signaling rate port (charging supported), 1 Universal audio combo

**Rear I/O** 2 DisplayPort<sup>™</sup> 1.4<sup>1</sup>, 1 RJ-45 port, 2 Type-A SuperSpeed USB 10Gbps signaling rate port

Optional: 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (optional, supports charging), 1

DisplayPort<sup>™</sup> 1.4<sup>1</sup>, 2 Flex IO modules

On-board RAID Support NVMe RAID 0 Striped Array

**NVMe RAID 1 Mirrored Array** 

**Chassis Dimensions** 

H: 2.28" [58mm] (Standard desktop orientation)

(**H x W x D**) W: 8.5" [216mm]

D: 8.5" [216mm]

**Packaged Dimensions** H: 11.73" (298mm)

W: 6.69" (170mm) D: 19.65" (499mm)



#### Overview

**Rack Dimensions** 5U

Weight Exact weights depend upon configuration

Minimum: 2.1kg (4.6lbs.) Maximum: 2.42kg (5.3lbs.)

**Temperature** Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1°C (1.8°F) for

every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

**Humidity** Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

**Power Supply** Choice of:

180W 89% Average Efficiency. 280W 89% Average Efficiency.

NOTES: Customers placing their system in an enclosure should design their solution to accommodate

the size of the external power supply for the Z2 Mini G5

**Workstation ISV** See the latest list of certifications at

Certifications http://www.hp.com/united-states/campaigns/workstations/partnerships.html

Chipset Intel® W480 chipset

Memory 2 SODIMM slots, supporting up to 64GB ECC/non-ECC, DDR4 2933 MT/s, speed depending on the CPU

selection.

<sup>1</sup>All DisplayPort™ support DP1.4/HBR2 when video output is via Intel Graphics. Discrete graphics

support DP1.4 / HBR3.

## **Supported Components**

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	10th Generation Intel Core Processors <sup>1</sup>				
	Intel® Core™ i9 10900K Processor	Υ	N		3
	Intel® Core™ i9 10900 Processor	Υ	N		
	Intel® Core™ i9 10900F Processor	Υ	N		1
	Intel® Core™ i7 10700K Processor	Υ	N		3
	Intel® Core™ i7 10700 processor	Υ	N		
	Intel® Core™ i5 10600K processor	Υ	N		3
	Intel® Core™ i5 10600 processor	Υ	N		
	Intel® Core™ i5 10500 processor	Υ	N		
	Intel® Core™ i5 10400 processor	Υ	N		
	Intel® Core™ i9 10400F Processor	Υ	N		1
	Intel® Core™ i3 10320 processor	Υ	N		2
	Intel® Core™ i3 10300 processor	Υ	N		2
	Intel® Core™ i3 10100 processor	Υ	N		
	Intel Xeon W Processors				
	Intel® Xeon® W-1290P processor	Υ	N		3
	Intel® Xeon® W-1290 processor	Υ	N		2
	Intel® Xeon® W-1270P processor	Υ	N		2,3
	Intel® Xeon® W-1270 processor	Υ	N		
	Intel® Xeon® W-1250P processor	Υ	N		3
	Intel® Xeon® W-1250 processor	Υ	N		

<sup>1</sup>These processors support only non-ECC memory

**NOTE 1:** No integrated graphics. A discrete graphics card must be purchased at the same time. Available in 04, 2020

in Q4, 2020

NOTE 2: Available in Q4, 2020

**NOTE 3:** TDP configured down to 95W.

Storage / Hard Drives*		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA Hard Drives				
	500GB SATA 7200 rpm 6Gb/s SFF HDD (2.5")	Υ	Υ	TOK73AA	
	1TB SATA 7200 rpm 6Gb/s SFF HDD (2.5")	Υ	Υ	TOK74AA/AT	
	2 TB SATA 5400 rpm SFF HDD (2.5")	Υ	N		
	500GB SATA 7.2K SED SFF HDD	Υ	Υ	D8N29AA	
	SATA Solid State Drives				
	HP 256GB SATA 6Gb/s SSD	Υ	Υ		
	HP 2TB SATA SSD PROMO			Y6P08AT	
	PCIe Solid State Drives				
	HP ZTurbo 1TB TLC Z2 G5 Mini SSD Kit	Υ	Υ	141L4AA/AT	
	HP ZTurbo 256GB SED Z2 G5 Mini SSD Kit	Υ	Υ	141L6AA/AT	
	HP ZTurbo 256GB TLC Z2 G5 Mini SSD Kit	Υ	Υ	141L9AA/AT	
	HP ZTurbo 2TB TLC Z2 G5 Mini SSD Kit	Υ	Υ	141M0AA/AT	

### **Supported Components**

HP ZTurbo 2TB TLC Z2 G5 TWR/SFF SSD Kit	Υ	Υ	141M1AA/AT
HP ZTurbo 512GB SED Z2 G5 Mini SSD Kit	Υ	Υ	141M2AA/AT
HP ZTurbo 512GB SED Z2 G5 TWR/SFF SSD Kit	Υ	Υ	141M3AA/AT
HP ZTurbo 512GB TLC Z2 G5 Mini SSD Kit	Υ	Υ	141M4AA/AT
HP ZTurbo 512GB TLC Z2 G5 TWR/SFF SSD Kit	Υ	Υ	141M5AA/AT

**NOTE1:** SATA hardware-assisted RAID is not supported on Linux® systems. The Linux® kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-assisted RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB

**NOTE2:** 125W CPU SKU is not supported to install the SATA 2.5in HDD or SSD.

NOTE3: 65W CPU and MXM GFX card SKU is not supported to install the SATA 2.5in HDD or SSD.

\*For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part S Number	Support Notes
	Graphics Cable Adapters				
	HP DisplayPort To HDMI True 4k Adapter	Υ	Υ	2JA63AA	
	HP DisplayPort To DVI-D Adapter	Υ	Υ	FH973AA	
	HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA	
	HP USB-C to DisplayPort Adapter	Υ	Υ	4SH08AA	
	HP USB-C to HDMI Adapter	Υ	Υ	4SH07AA	
	HP USB-C to VGA Adapter	Υ	Υ	4SH06AA	
	Entry 3D				
	AMD Radeon™ Pro WX 3200 4GB MXM Graphics	Υ	N		
	NVIDIA® Quadro® P620 4GB MXM Graphics	Υ	N		1
	Mid-range 3D				
	NVIDIA® Quadro® T1000 4GB MXM Graphics	Υ			
	NVIDIA® Quadro® T2000 4GB MXM Graphics	Υ			
	NVIDIA® Quadro® RTX 3000 6GB MXM Graphics	Υ	N		2
	<b>NOTE 1:</b> Available in Q4, 2020 <b>NOTE 2:</b> Available in Q1, 2021				

Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 4GB (1x4GB) DDR4-3200 nECC SO DIMM	Υ			
	HP 8GB (2x4GB) DDR4-3200 nECC SO DIMM	Υ			
	HP 8GB (1x8GB) DDR4-3200 nECC SO DIMM	Υ			
	HP 8GB (1x8GB) DDR4-3200 ECC SO DIMM	Υ			
	HP 16GB (2x8GB) DDR4-3200 nECC SO DIMM	Υ			
	HP 16GB (2x8GB) DDR4-3200 ECC SO DIMM	Υ			
	HP 16GB (1x16GB) DDR4-3200 nECC SO DIMM	Υ			
	HP 16GB (1x16GB) DDR4-3200 ECC SO DIMM	Υ			



### **Supported Components**

HP 32GB (2x16GB) DDR4-3200 nECC SO DIMM	Υ	
HP 32GB (2x16GB) DDR4-3200 ECC SO DIMM	Υ	
HP 32GB (1x32GB) DDR4-3200 nECC SO DIMM	Υ	
HP 32GB (1x32GB) DDR4-3200 ECC SO DIMM	Υ	
HP 64GB (2x32GB) DDR4-3200 nECC SO DIMM	Υ	
HP 64GB (2x32GB) DDR4-3200 ECC SO DIMM	Υ	
AMO		
HP 4GB (1x4GB) DDR4-3200 nECC SO DIMM	N	141J0AA/AT
HP 8GB (1x8GB) DDR4-3200 nECC SO DIMM	N	141J5AA/AT
HP 8GB (1x8GB) DDR4-3200 ECC SO DIMM	N	141J2AA/AT
HP 16GB (1x16GB) DDR4-3200 nECC SO DIMM	N	141H5AA/AT
HP 16GB (1x16GB) DDR4-3200 ECC SO DIMM	N	141H4AA/AT
HP 32GB (1x32GB) DDR4-3200 nECC SO DIMM	N	141H8AA/AT
HP 32GB (1x32GB) DDR4-3200 ECC SO DIMM	N	141H6AA/AT

**NOTES:** The CPUs determine the speed at which the memory is clocked. If a 2666 MHz capable CPU is used in the system, the maximum speed the memory will run at is 2666 MHz regardless of the specified speed of the memory.

Intel® Xeon® W processors can support either ECC or non-ECC memory; Intel® Core™ i3/i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

Optical	and	Removable	
Storage	<b>e</b>		

	ractory Configured	Option Kit	Option Kit Part Number	
HP Slim Tray Optical Drives				
HP External IIItra-Slim DVD-RW Drive	N	V	<b>Υ</b> 3Τ76ΔΔ	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

<b>Networking and</b>
Communications

	Factory Configured	Option Kit	Option Kit Part Number
Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel AMT 12.0)	Υ	N	
Intel Wi-Fi 6 AX201 (2x2) and Bluetooth 5 combo	Υ	N	
HP 1GbE LAN Flex Port 2020	Υ	Υ	141J6AA/AT
HP 2.5GbE LAN Flex Port Z2 Mini	Υ	Υ	169KOAA/AT

**NOTE 1:** The integrated network connection is required to support Intel® vPro™ Technology. **NOTE 2:** If AMT is provisioned, then network teaming with the integrated LAN port is not possible. **NOTE 3:** "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



## **Supported Components**

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Keyed Cable Lock 10mm	N	Υ	T1A62AA
	Z2 Mini ePSU Sleeve	N	Υ	3RW68AA
	HP Z2 Mini Vertical Stand	N	Υ	3RW66AA
	HP Z2 Mini VESA Sleeve	N	Υ	Y7B61AA
	HP Business PC Security Lock v3 Kit	N	Υ	3XJ17AA
	HP Z2 Mini Rack Tray Support Kit	N	Υ	1A4W4AA
	HP Z2 Mini and TWR/Z4/Z6 G4 Depth Adjustable Fixed Rail Rack Kit	N	Υ	2HW42AA/AT
	Z2 G5 Mini HDD Carrier Cage	Y	Υ	1X5Q2AA/AT
Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP Premium Wireless Keyboard	Υ	Υ	Z9N41AA/AT
	HP USB 320K Keyboard	Υ	Υ	9SR37AA
	HP USB Business Slim Wired Smartcard CCID Keyboard	Υ	N	
	HP Wireless Business Slim Keyboard and Mouse	Υ	Υ	
	HP USB Premium Wired Keyboard	Υ	Υ	Z9N40AT
	HP 320M Wired Mouse	Υ	Υ	9VA80AA
	HP USB Premium Mouse	Υ	Υ	1JR32AA
	HP Wireless Premium Mouse	Υ	Υ	1JR31AA
	3Dconnexion CAD Mouse	N	Υ	M5C35AA
	HP Wired Desktop 320MK Mouse and Keyboard	N	Υ	9SR36AA
Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Z2 Power Cord Kit	Υ	Υ	1N1D5AA
	HP DP Flex Port 2020	Y	Y	141J7AA/AT
	HP Dual USB-A 3.2 Gen1 Flex Port 2020	Y	Y	141J8AA/AT
	HP Dual USB-A 3.2 Gen1 Flex Port 2020 Mini	Y	Y	141J9AA/AT
	HP USB-C® 3.2 Gen2 Alt Flex Port 2020	Y	Y	141K6AA/AT
	HP HDMI Flex Port 2020	Y	Y	141K1AA/AT
	HP VGA Flex Port 2020	Y	Y	141K7AA/AT
	HP Mini Serial Upper Flex Port 2020 Mini HP Thunderbolt™ 3 Flex Port 2020 Mini	Y Y	Y Y	141K2AA/AT 141K4AA/AT
Software				
JUILWAIE		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Y	N	1
	HP PC Hardware Diagnostics UEFI (Windows OS only)	Υ	N	2
	HP PC Hardware Diagnostics Windows	Υ	N	



### Supported Components

ZCentral Remote Boost	Υ	N
HP Sure Sense	Υ	N
HP Notifications	Υ	N
HP Desktop Support Utility	Υ	N
HP Documentation	Υ	N
HP Image Assistant	N	N
HP Support Assistant	N	N

**NOTE 1:** Supports and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor

**NOTE 2:** Windows OS only

#### **Operating Systems**

Windows 10 Pro 64

Windows 10 Pro 64 High End

Windows 10 Pro 64 Workstation Plus

Windows 10 Home 64 Plus

Windows 10 Home 64 Advanced

Linux Ready

**NOTE:** For detailed QS/hardware support information for Linux, see:

http://www.hp.com/support/linux\_hardware\_matrix

#### **HP BIOS**

#### Kev features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate
  the HP Z2 G5 Workstation into the enterprise, such as PXE, remote recovery, remote
  configuration, remote control, and BIOS (F10) Setup support for 15 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.7
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:



### Supported Components

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
- -Power to expansion connectors / slots
- -Wake events other than power buttons (such as wake on LAN)
- -USB charging ports

#### **HP Sure Start Gen6 Start**

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed
  and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while
  the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is
  policy driven for better manageability. Start is set by default to automatically repair the BIOS
  if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.

#### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### **BIOS**

HP BIOSphere Gen6<sup>10</sup>
BIOS Update via Network
HP Secure Erase<sup>11</sup>
Absolute Persistence Module<sup>12</sup>
Pre-boot Authentication
HP Wake on WLAN
HP DriveLock & Automatic DriveLock <sup>13</sup>

#### Software

HP Support Assistant
HP Image Assistant
HP Desktop Support Utility
HP Documentation
HP Notifications
HP PC Hardware Diagnostics UEFI
HP PC Hardware Diagnostics Windows
HP Performance Advisor<sup>3</sup>
ZCentral Remote Boost<sup>14</sup>



### Supported Components

#### **Manageability Features**

HP Driver Packs<sup>1</sup>
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Manageability Integration Kit Gen4<sup>2</sup>

#### **Client Security Software**

HP Client Security Manager Gen6<sup>4</sup> HP Device Access Manager HP Power On Authentication Microsoft Defender<sup>5</sup>

#### **Security Management**

HP Sure Click<sup>9</sup>
HP Sure Start Gen6<sup>6</sup>
HP Sure Run Gen3<sup>7</sup>
HP Sure Sense<sup>15</sup>
HP Sure Recover Gen3<sup>8</sup>

- 1. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 2. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html

3. HP Performance Advisor Software - HP Performance Advisor is ready and waiting to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at:

https://www8.hp.com/us/en/workstations/performance-advisor.html

- 4. HP Client Security Manager Gen6 requires Windows and is available on select HP Pro, Elite and Workstation PCs. See product specifications for details..
- 5. Microsoft Defender Opt in and internet connection required for updates.
- 6. HP Sure Start Gen6 is available on HP Workstation products equipped with Intel® 8th generation processors or later
- 7. HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.
- 8. HP Sure Recover Gen3: See product specifications for availability. Requires an open, wired network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PC's with Intel Wi-Fi Module.
- 9. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.
- 10. HP BIOSphere Gen6 is available on select HP Pro, Elite and Workstation PCs. See product specifications for details. Features may vary depending on the platform and configurations.
- 11. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- 12. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

- 13. Storage Drivelock does not work with Self Encrypting or Optane based storage.
- 14. HP Z Central Remote Boost Software does not come preinstalled on Z Workstations but can be downloaded and run on all Z desktop and laptops without license purchase. With non-Z sender devices, purchase of perpetual individual license or perpetual floating license per simultaneously executing versions and purchase of ZCentral Remote Boost Software Support is required. RGS requires Windows, RHEL (7 or 8), UBUNTU 18.04 LTS, or HP ThinPro 7 operating systems. MacOS (10.13 or newer) operating system is only supported on the receiver side. Requires network access. The software is available for download at hp.com/ZCentralRemoteBoost.
- 15. HP Sure Sense requires Windows 10 Pro or Enterprise. See product specifications for availability.



### System Technical Specifications

**System Board** 

**System Board Form** 

**Factor** 

202.2 x 198.5 mm (7.96 x 7.815 inch)

**Processor Socket** Single LGA-1200

**CPU Bus Speed** DMI

Chipset Intel® PCH W480

Super I/O Controller Nuvoton SI018

Memory Expansion Slots 2 DDR4 memory slots

Memory Type Supported DDR4, SODIMM ECC & non-ECC

**Memory Modes** Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 2933MT/s DDR4

**Memory Protection** ECC available on data

64GB **Maximum Memory** 

**Memory Configuration** 

(Supported)

4GB, 8GB 16GB and 32GB non-ECC and 8GB, 16GB and 32GB ECC SO DIMMs are supported. ECC and

non-ECC memory DIMMs cannot be mixed in the same system

**PCI Express Connectors** 1 MXM PCI Express Gen3 slot x1

2 M.2 Storage (PCle Gen3 x4)

• 1 M.2 WLAN (PCIe Gen3 x1+ Intel CNVi)

**Supported Drive** 

Interfaces

**SATA** Integrated (1) Serial ATA interfaces (6Gb/s SATA).

**Network Controller** Integrated Ethernet PHY Connection I219LM. Management capabilities:

WOL, PXE 2.1 and AMT 12

Serial 1 rear port (requires optional Serial Port Adapter Kit)

**HD Integrated Audio** Yes

**USB Connector(s) Front** 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge supports

up to 5V/2.1A); 1 Type-C® SuperSpeed USB 10Gbps signaling rate port

(charge supports up to 5V/3A)

2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® Rear

> SuperSpeed USB 10Gbps signaling rate port (optional); 1 Type-C® SuperSpeed USB 10Gbps signaling rate Alt mode port (optional via Flex)

Internal 2 Type-A SuperSpeed USB 5Gbps signaling rate port

**HD Integrated Audio** 

Yes Flash ROM Yes **CPU Fan Header** Yes **Memory Fan Header** None **Chassis Fan Header** None

Front PCI Fan Header 1 GPU Fan (most)

### System Technical Specifications

Front Control

Yes

Yes

Panel/Speaker Header

CMOS Battery Holder -

Lithium

**Integrated Trusted** 

Integrated TPM 2.0

**Platform Module** Convertible to FIPS 140-2 Certified mode through firmware v7.85

The TPM module disabled where restricted by law, i.e. Russia.

**Power Supply Headers** DC Jack for adapter

Power Switch, Power LED Yes

& Hard Drive LED Header

Clear Password Jumper None

**Keyboard/Mouse** USB

**Operating Voltage Range** 90-269 VAC

Rated Voltage Range 100–240 VAC

**Rated Line Frequency** 50-60 Hz

Operating Line Frequency 47-66 Hz

Range

Rated Input Current 6A@100-240V

**Heat Dissipation** Typical: 444 btu/hr (112 kcal/hr)

Maximum: 1484 btu/hr (374 kcal/hr)

**ENERGY STAR® certified** 

(Config Dependent)

Yes

CECP Compliant @ 220V Ye

**FEMP Standby Power** 

**Compliant** 

Yes, with Wake-on-LAN disabled: <2W in S5- Power Off

Built-in Self Test (BIST)

LED

Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V) Yes

No

**System Configurations** 

Z2 Mini G5 Configuration

Processor Info CPU I Core i5-10400 2.9GHz 6C65W

Memory Info 8GB (1x 8GB) 2666 MHz DDR4 non-ECC

**ENERGY STAR CERTIFIED** 

Intel® UHD Integrated Graphics 630

Disks/Optical/Floppy 1x SATA 1TB 7.2k rpm

Power Supply 180W

**Graphics Info** 

Energy Consumption 115 VAC 230 VAC 100 VAC

#1

## **System Technical Specifications**

(Watts)

	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	7.	38	8.	76	7.	7.03	
Windows short Idle (S0)	10	10.74		12.02		9.96	
Windows Busy Typ (S0)	90.37		99.52		88.23		
Windows Busy Max (S0)	95	.11	102.78		93	.86	
Sleep (S3)	0.78	0.45	0.82	0.51	0.73	0.41	
Off (S5)	0.59	0.57	0.61	0.59	0.57	0.56	
Zero Power Mode (ErP)	0.21		0.	22	0	.2	

Heat Dissipation (Btu/hr)

	115	VAC	230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
Windows long Idle (S0)	25.	25.181		29.889		23.986	
Windows short Idle (S0)	36.645		41.012		33.984		
Windows Busy Typ (S0)	308	.342	339.562		301.041		
Windows Busy Max (S0)	324	.515	350.685		320	0.25	
Sleep (S3)	2.661	1.535	2.798	1.74	2.491	1.399	
Off (S5)	2.013	1.945	2.081	2.013	1.945	1.911	
Zero Power Mode (ErP)	0.7	0.717		0.751		0.682	

Z2 Mini G5 Configuration

#2

Processor Info CPU I Core i7-10700 2.9GHz 8C65W

Memory Info 16GB (2x 8GB) 2666 MHz DDR4 non-ECC

Graphics Info T1000 Graphics
Disks/Optical/Floppy 1x SATA 256GB SSD

Power Supply 280W

Energy Consumption (Watts)

	115 VAC		115 VAC 230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	15.23		15.63		15.01	
Windows short Idle (S0)	18.35		18.82		17.98	
Windows Busy Typ (S0)	109.47		109.88		107.36	
Windows Busy Max (S0)	14	0.9	142.95		138.56	
Sleep (S3)	1.13	0.73	1.15	0.78	1.1	0.69
Off (S5)	0.62	0.61	0.63	0.61	0.61	0.6
Zero Power Mode (ErP)	0.21		0.	23	0	.2

Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	51.965		53.33		51.214	
Windows short Idle (S0)	62.61		64.214		61.348	
Windows Busy Typ (S0)	373.512		374.911		366.312	
Windows Busy Max (S0)	480.	.751	487.745		472.767	
Sleep (S3)	3.856	2.491	3.924	2.661	3.753	2.354
Off (S5)	2.115	2.081	2.15	2.081	2.081	2.047
Zero Power Mode (ErP)	0.717		0.785		0.682	

*Z2 Mini G5 Configuration* #3

Processor Info Memory Info CPU I Core i9-10900K 3.7GHz 10C125W 64GB (2x 32GB) 2666 MHz DDR4 ECC

**ENERGY STAR CERTIFIED** 

**Graphics Info** 

T1000 Graphics

## **System Technical Specifications**

Disks/Optical/Floppy 1x SATA 512GB SSD

Power Supply 280W

Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	15	15.31		16.52		15.06	
Windows short Idle (S0)	18.74		19.04		18.32		
Windows Busy Typ (S0)	152	152.66		153.69		150.02	
Windows Busy Max (S0)	191	1.14	197.91		189.96		
Sleep (S3)	1.94	1.5	2.07	1.64	1.91	1.45	
Off (S5)	0.62	0.6	0.63	0.61	0.61	0.6	
Zero Power Mode (ErP)	0.23		0.	24	0.	22	

Heat Dissipation (Btu/hr)

	115	VAC	230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
Windows long Idle (S0)	52.	52.238		56.366		51.385	
Windows short Idle (S0)	63.941		64.964		62.508		
Windows Busy Typ (S0)	520	.876	524.39		511.868		
Windows Busy Max (S0)	652	2.17	675.269		648	.144	
Sleep (S3)	6.619	5.118	7.063	5.596	6.517	4.947	
Off (S5)	2.115	2.047	2.15	2.081	2.081	2.047	
Zero Power Mode (ErP)	0.785		0.819		0.751		

Z2 Mini G5 Configuration

#4

**ENERGY STAR CERTIFIED** 

Processor Info CPU Xeon W-1250 3.3GHz 6C80W
Memory Info 16GB (2x 8GB) 2666 MHz DDR4 ECC

Graphics Info T2000 Graphics

Disks/Optical/Floppy 1x SATA 1TB SSD Z Turbo

Power Supply 280W

Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	15	.48	15	15.94		15.25	
Windows short Idle (S0)	19.47		19.5		19.13		
Windows Busy Typ (S0)	120.03		123.49		118.69		
Windows Busy Max (S0)	175	5.99	176.23		172.33		
Sleep (S3)	1.21	1.09	1.23	1.11	1.18	1.06	
Off (S5)	0.64	0.63	0.66	0.64	0.6	0.59	
Zero Power Mode (ErP)	0.22		0.	24	0.	.21	

Heat Dissipation (Btu/hr)

	115 VAC		230	VAC	100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
Windows long Idle (S0)	52.818		54.387		52.033		
Windows short Idle (S0)	66.432		66.534		65.272		
Windows Busy Typ (S0)	409	409.542		421.348		404.97	
Windows Busy Max (S0)	600	.478	601.297		587	7.99	
Sleep (S3)	4.129	3.719	4.197	3.787	4.026	3.617	
Off (S5)	2.184	2.15	2.252	2.184	2.047	2.013	
Zero Power Mode (ErP)	0.751		3.0	319	0.7	717	

## **System Technical Specifications**

### **Declared Noise Emissions**

System Configuration (Entry level)	Processor Info	W-1250P COMET LAKE WS P-1 6c LGA 1250P COMET LAKE WS Q-0 6c LGA 4.1 Supplemental QS					
	Memory Info	Hynix (TG) 8GB 3200 DDR4 SODIMM ECC x2					
	Graphics Info	T2000					
	Disks/Optical/Floppy	SSD Z Turbo Drive 256GB 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SS					
	Power Supply	280W					
<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
7779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	SSD 512GB M.2 2280 PCIe NVMe Three Layer Cell 3rd					
System Configuration (Mid-level)	Processor Info	W-1290 COMET LAKE WS P-1 10c LGA 8 COMET LAKE WS Q-0 10c LGA 3.2 GHz 8	• • •				
	Memory Info	Samsung (TH) 8GB 3200 DDR4 SODIMM ECC x1					
	Graphics Info	T1000					
	Disks/Optical/Floppy	NA					
	Power Supply	280W					
<b>Declared Noise Emissions</b> (in accordance with ISO		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
7779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	HDD 500GB 7200RPM SATA SFF Self Encrypted Drive OPAL2					
System Configuration	Processor Info	15-10400 COMET LAKE G-0 6c LGA 65W	/ MS0 QS				
(High-end)	Memory Info	Hynix (TG) 8GB 3200 DDR4 SODIMM ECC x1					
	Graphics Info	Intel UHD Graphics					
	Disks/Optical/Floppy	SSD Z Turbo Drive 512GB 2280 Three L	ayer Cell 2nd				
	Power Supply	280W					
<b>Declared Noise Emissions</b> (in accordance with ISO		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
7779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in					
System Configuration	Processor Info	13-10320 COMET LAKE G-0 6c LGA 65W	/ T3 4(f)+2 QS				
(Mid-level)	Memory Info	Micron (TF) 8GB 3200 DDR4 SODIMM ECC x2					
	Graphics Info	Intel UHD Graphics					
	Disks/Optical/Floppy	SSD Z Turbo Drive 512GB 2280 Three L	ayer Cell 2nd				
	Power Supply	180W					



## **System Technical Specifications**

<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
7779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in					
ystem Configuration	Processor Info	13-10100 COMET LAKE G-0 6c LGA 65W	T1 4(f)+2 QS				
High-end)	Memory Info	Micron (TF) 8GB 3200 DDR4 SODIMM ECC x2					
	Graphics Info	Intel UHD Graphics					
	Disks/Optical/Floppy	ZTRB HP Z Turbo Drive QX310 256GB S	SD				
	Power Supply	180W					
<b>Declared Noise Emissions</b> in accordance with ISO		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
7779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in					
ystem Configuration	Processor Info	I9-10900 COMET LAKE P-1 10c LGA 65W P2 vPro™ QS					
(Mid-level)	Memory Info	Micron (TF) 4GB (1x4GB) 3200 DDR4 SODIMM NECC	x2				
	Graphics Info	Intel UHD Graphics					
	Disks/Optical/Floppy	ZTRB HP Z Turbo Drive QX310 256GB SSD					
	Power Supply	180W					
eclared Noise Emissions in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
779 and ISO 9296)	Idle	TBD	TBD				
	Hard drive Operating (random reads)	ZTRB HP Z Turbo Drive QX310 256GB SSD					
ystem Configuration	Processor Info	15-10500 COMET LAKE G-0 6c LGA 65W	MS1 vPro™ QS				
High-end)	Memory Info	Samsung (TH) 4GB (1x4GB) 3200 DDR4 SODIMM NECC x2					
	Graphics Info	Intel UHD Graphics					
	Disks/Optical/Floppy	SSD Z Turbo Drive 512GB 2280 PCIe NVMe Self Encrypted OPAL2 T Layer Cell SS					
	Power Supply	180W					
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
	Idle	TBD	TBD				
	Hard drive Operating (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in					

Environmental Requirements

**Temperature** Operating: 5° to 35° C (40° to 95° F)

Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

**Humidity** Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb



### **System Technical Specifications**

Maximum Altitude Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Cooling for details.

**Dynamic** Shock

Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g<sup>2</sup>/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g<sup>2</sup>/Hz

**Cooling** Above 1524 m (5,000 feet) altitude, the maximum operating temperature

is reduced by 1°C (1.8°F) for every 305 m (1,000 feet) increase in elevation,

up to 3048 m (10,000 feet)



### System Technical Specifications

### **Physical Security and Serviceability**

**Access Panel** Tool-less

Has to remove Top panel before Bottom panel be removed.

**Optical Drive** 

**Hard Drives** HDD cage requires the use of a screwdriver to remove the HDD

**Expansion Cards** M.2 module requires a screwdriver to service and replace.

An option card requires a screwdriver to service and replace.

**Processor Socket** Tool-less, except for the processor heatsink

**Blue User Touch Points** Yes, on internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less

**System Board** Screw-In

**LED on Front of Computer** 

**Dual Color Power and HD** The Power LED is on the front of the system, but the HDD LED is located on the Rear of the system

Restore CD/DVD Set Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original

> operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP

Support.

**Dual Function Front** 

**Power Switch** 

Yes, causes a fail-safe power off when held for 4 seconds (default) or 15 seconds (can be configured by

F10 BIOS setup\Advanced\System Options\Power button override)

**Padlock Support** No

Cable Lock Support Yes, Kensington Cable Lock (optional): Locks top cover from being opened and secures chassis to

furniture to prevent theft

3 mm x 7 mm slot at rear of system

**Universal Chassis Clamp** 

Lock Support

No

Solenoid Lock and Hood

Sensor

Only Hood Sensor(optional)

**Rear Port Control Cover** No

Serial. USB. Audio.

Network, Enable/Disable Mini G5)

Yes, enables or disables serial, USB, audio, and network ports (parallel port is not supported on the Z2

**Port Control** 

Power-On Password No

3.3V Aux Power LED on

System PCA

No

NIC LEDs (integrated)

(Green & Amber)

Yes

**CPUs and Heatsinks** A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be

removed. CPU removal is tool-less

### System Technical Specifications

**Power Supply Diagnostic** Yes; this is located on the Rear of the chassis and combined with the HDD LED.

When the PSU adapter is plugged in, and the unit is powered off, the Power OK LED will glow.

**Front Power Button** Yes

**Front Power LED** Yes, white (normal), red (fault)

**LED** 

Front Hard Drive Activity HDD LED is located on the Rear of the chassis

Front ODD Activity LED No **Internal Speaker** Yes

Air cooled forced convection **Cooling Solution** 

**Power Supply Fans** No **Memory Heatsink Fan** No

**Access Panel Key Lock** The Kensington lock slot on the chassis serves this purpose

Integrated Chassis

Handles

Nο

**Power Supply** No Flash ROM Yes

Diagnostic Power Switch Yes

LED on board

**Clear CMOS Button** Yes

**CMOS Battery Holder** Yes

**DIMM Connectors** Yes

BIOS

**BIOS 32-bit Services** BIOS supports 64-bit Operating systems.

**PCI 3.0 Support** Full BIOS support for PCI Express through industry standard interfaces.

ATAPI Removable Media Device BIOS Specification Version 1.0. **ATAPI** 

BIOS Boot Specification v1.01. **BBS** 

**WMI Support** WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is

fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

BIOS Boot Spec 1.01+

Provides more control over how and from what devices the workstation will boot.

**BIOS Power On** Users can define a specific date and time for the system to power on.

**ROM Based Computer** Setup Utility (F10)

Review and customize system configuration settings controlled by the BIOS.

System/Emergency ROM Flash Recovery with

Video Recovers system BIOS in corrupted Flash ROM.

### System Technical Specifications

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). **Replicated Setup** 

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup).

**SMBIOS** System Management BIOS 3.2, for system management information.

Disables the ability to boot from removable media on supported devices. **Boot Control** 

**Memory Change Alert** Alerts management console if memory is removed or changed. **Thermal Alert** Monitors the temperature state within the chassis. Three modes:

• NORMAL - normal temperature ranges.

ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid

shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

Remote ROM Flash Provides secure, fail-safe ROM image management from a central network console.

ACPI (Advanced Allows the system to enter and resume from low power modes (sleep states). Configuration and Power Enables an operating system to control system power consumption based on the dynamic workload.

Management Interface) Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 6.0 for full compatibility with 64-bit operating systems.

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. **Ownership Tag** 

Remote Wakeup/Remote

Shutdown System administrators can power on, restart, and power off a client computer from a remote location.

**Instantly Available PC** (Suspend to RAM - ACPI

sleep state S3) Allows for very low power consumption with quick resume time.

**Remote System Installation via F12 (PXE** 

2.1) (Remote Boot from Allows a new or existing system to boot over the network and download software, including the

Server)

operating system. **ROM revision levels** Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

**System board revision** 

Allows management SW to read revision level of the system board. level Revision level is digitally encoded into the HW and cannot be modified.

Start-up Diagnostics (Power-on Self-Test)

Assesses system health at boot time with selectable levels of testing.

**Auto Setup when new** hardware installed

System automatically detects addition of new hardware.

**Keyboard-less Operation** The system can be booted without a keyboard.

**Localized ROM Setup** Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with

local keyboard mappings.

**Asset Tag** The user or MIS to set a unique tag string in non-volatile memory.

**Per-slot Control** Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Control parameters are set according to detected hardware configuration for optimal acoustics. **Adaptive Cooling Pre-boot Diagnostics** (Pre-video) critical errors are reported via beeps and blinks on the power LED.

**Industry Standard** Revision Supported by the BIOS

**UEFI Specification** 

Revision 2.7

**ACPI** Advanced Configuration and Power Management Interface, Version 6.0 AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b ATA (IDE) **CD Boot** "El Torito" Bootable CD-ROM Format Specification Version 1.0

**EDD** Enhanced Disk Drive Specification Version 1.1

BIOS Enhanced Disk Drive Specification Version 3.0



### System Technical Specifications

Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 **EHCI** 

PCI PCI Local Bus Specification. Revision 2.3

> PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

PCI Express Base Specification, Revision 2.0 **PCI Express** 

PCI Express Base Specification, Revision 3.0

**SATA** Serial ATA Specification, Revision 1.0a

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B

**TPM** Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670).

Common Criteria EAL4+ certified.

FIPS 140-2 Certification TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

**USB** Universal Serial Bus Revision 1.1 Specification

Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification

**SMBIOS** System Management BIOS Reference Specification, Version 3.2

External BIOS simulator found at: http://csrsml.itcs.hp.com/

### Social and Environmental Responsibility

Eco-Label Certifications & This product is low halogen except for power cords, cables and peripherals. Service parts obtained **Declarations** after purchase may not be Low Halogen.

- ENERGY STAR® (energy-saving features available on selected configurations –Windows® only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program (CECP)
- IT ECO declaration

**Batteries** The battery in this product complies with EU Directive 2006/66/EC

> Battery size: CR2032 (coin cell) Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

**Restricted Material Usage** This product meets the material restrictions specified in HP's General Specification for the

Environment. http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

and Recycling

**End-of-Life Management** HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.



### System Technical Specifications

HP Inc. Corporate Environmental Information For more information about HP's commitment to the environment:

Living Progress Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

#### ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

#### **Additional Information**

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product is >90% recycle-able when properly disposed of at end of life
- EPEAT®2019 Gold registered in the United States\*

\*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information.

#### Packaging

HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen\_specifications.html

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

#### **Packaging Materials**

Internal

Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expanded-polypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).

**External** 

Carton made from corrugated fiberboard with at least 35% recycled content.



### **System Technical Specifications**

### Manageability

Remote Manageability Software Solutions

The HP Z2 G5 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager

For questions or support for manageability needs, please visit

http://www.hp.com/go/clientmanagement

HP Image Assistant System Software Manager Visit: http://ftp.hp.com/pub/caps-softpaq/cmit/HPIA.html

For questions or support for SSM, please visit: http://www.hp.com/go/ssm



### Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering	
		Intel Core i3-10100 3.6 4C 65W processor	
		Intel Core i5-10500 3.1 6C 65W processor	
		Intel Core i5-10600 3.3 6C 65W processor	
		Intel Core i7-10700 2.9 8C 65W processor	
		Intel Xeon W-1250 3.3 6C 80W processor	
		Intel Xeon W-1250P 4.1 6C 125W processor	
Hard Drives	Product #	Offering	
		1TB 7200RPM 9.5mm SATA 2.5 HDD	
Graphics	Product #	Offering	
		AMD Radeon™ Pro WX 3200 4GB	



### **Technical Specifications - Processors**

#### **10th Generation Intel Core Processors**

Intel® Core™ i9-10900K Processor

Intel® Core™ i9-10900 Processor

Intel® Core™ i9-10900F Processor1

Intel® Core™ i7-10700K Processor

Intel<sup>®</sup> Core<sup>™</sup> i7-10700 processor

Intel® Core™ i5-10600K processor

Intel<sup>®</sup> Core<sup>™</sup> i5-10600 processor

Intel<sup>®</sup> Core<sup>™</sup> i5-10500 processor

Intel<sup>®</sup> Core<sup>™</sup> i5-10400 processor

Intel® Core™ i5-10400F Processor¹

Intel® Core™ i3-10320 processor<sup>1</sup>

Intel® Core™ i3-10300 processor<sup>1</sup>

Intel® Core™ i3-10100 processor

#### **Intel Xeon W Processors**

Intel® Xeon® W-1290P processor

Intel® Xeon® W-1290 processor1

Intel® Xeon® W-1270P processor<sup>1</sup>

Intel® Xeon® W-1270 processor

Intel® Xeon® W-1250P processor

Intel® Xeon® W-1250 processor

NOTE 1: Available in Q4, 2020



### Technical Specifications - Hard Drives

SATA Hard Drives for HP Workstations

500GB SATA 7200 rpm 6Gb/s 2.5" HDD 
 Capacity
 500GB

 Protocol
 SATA

 Form Factor
 SFF (2.5")

 Controller
 AHCI

 Rated for 24/7/365
 NO

operation

Physical Size (Height)0.28 in; .7 cmPhysical Size (Width)2.75 in; 6.99 cmMedia Diameter2.5 in; 6.36 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s\*

**Operating Temperature** 32° to 140° F (5° to 55° C)

\*Actual performance may vary.

1TB SATA 7200 rpm 6Gb/s 2.5" HDD Capacity 1TB
Protocol SATA
Form Factor SFF (2.5")
Controller AHCI
Rated for 24/7/365 NO
operation

Physical Size (Height)0.28 in; .7 cmPhysical Size (Width)2.75 in; 6.99 cmMedia Diameter2.5 in; 6.36 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s\*

\*Actual performance may vary.

2TB SATA 7200 rpm 6Gb/s 2.5" HDD Capacity2TBProtocolSATAForm FactorSFF (2.5")ControllerAHCI

Physical Size (Height)0.28 in; .7 cmPhysical Size (Width)2.75 in; 6.99 cmMedia Diameter2.5 in; 6.36 cm

**Operating Temperature** 32° to 140° F (5° to 55° C)

\*Actual performance may vary.

500GB SATA 7.2K SED 2.5" HDD

Capacity500GBProtocolSATAForm Factor2.5"

Physical Size (Height)0.275 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmMedia Diameter2.75 in; 6.99 cm

25ms (Typical)\*

### Technical Specifications - Hard Drives

Interface Serial ATA (6Gb/s), NCQ enabled

**Synchronous Transfer** Up to 600MB/s\*

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track 1ms\* includes controller Average 4.2ms\* overhead, including - u.s. 1

settling)

Full Stroke

7 200 .....

**Rotational Speed** 7,200 rpm

**Operating Temperature** 32° to 131° F (0° to 60° C)

Self-Encrypting Drive

Yes

Support

HP 256GB SATA 6Gb/s SSD Capacity256GBProtocolSATAForm Factor2.5"

**Physical Size** (Height) 0.28 in; 0.7 cm **Physical Size** (Width) Physical Size

Synchronous Transfer

Up to 550MB/s (Sequential Read)\*

Rate (Maximum)

**Operating Temperature** 32° to 158° F (0° to 70° C)

## PCIe SSDs for HP Workstations

<b>HP Z Tur</b>	bo Drv	ı 256GB
TI C PCIe	SSD (	72G5)

Capacity 256GB Protocol PCIe

**Form Factor** M.2 in native slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 75TBW (TB Written)

Reliability (MTBF) 1.5M hours
Interface PCI Express 3.0 x4
Operating Temperature 32° to 158° F (0° to 70° C)

**Performance Sequential Read** 2800 MB/s\*

Sequential Write 1100MB/s\*
Random Read 250K IOPS\*
Random Write 180K IOPS\*

HP Z Turbo Drv 512GB TLC PCIe SSD (Z2G5) Capacity 512GB Protocol PCIe

**Form Factor** M.2 in native slot on motherboard

Controller NVMe
NAND Type 3D TLC



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### Technical Specifications - Hard Drives

**Endurance** 150TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800 MB/s\*

Sequential Write 1600MB/s\*
Random Read 260K IOPS\*
Random Write 260K IOPS\*

HP Z Turbo Drv 1TB TLC PCIe SSD (Z2G5) Capacity 1TB Protocol PCIe

**Form Factor** M.2 in native slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 300TBW (TB Written)

**Reliability** (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3000 MB/s\*

Sequential Write 1700MB/s\*
Random Read 360K IOPS\*
Random Write 330K IOPS\*

<sup>\*</sup>Actual performance may vary.

HP Z	Turbo	Drv	2TB
TLC P	Cle S	SD (Z	(2G5)

Capacity 2TB Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 600TBW (TB Written)

Reliability (MTBF) 1.5M hours

InterfacePCI Express 3.0 x4 electricalOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 3000 MB/s\*

Sequential Write 2100MB/s\*
Random Read 320K IOPS\*
Random Write 265K IOPS\*

HP Z Turbo Drv 256GB TLC PCIe SED OPAL2 (Z2G5) Capacity 256GB Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### **Technical Specifications - Hard Drives**

**Endurance** 75TBW (TB Written)

Reliability (MTBF) 1.5M Hours

Interface PCI Express 3.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s\*

OPAL2

Sequential Write 1100MB/s\*
Random Read 250K IOPS\*
Random Write 180K IOPS\*

Self-Encrypting Drive

Support

\*Actual performance may vary.

HP Z Turbo Drv 512GB TLC PCIe SED

**OPAL2 (Z2G5)** 

Capacity 512GB Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 150TBW (TB Written)

Reliability (MTBF) 1.5M Hours

Interface PCI Express 3.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800MB/s\*

OPAL2

Sequential Write 1600MB/s\*
Random Read 260K IOPS\*
Random Write 260K IOPS\*

Self-Encrypting Drive

Support

\*Actual performance may vary.

HP Z Turbo Drv 1TB TLC PCIe SED OPAL2 (Z2G5) Capacity 1TB Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 300TBW (TB Written)

Reliability (MTBF) 1.5M Hours

**Interface** PCI Express 3.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance** Sequential Read 3000MB/s\*

OPAL2

Sequential Write 1700MB/s\*
Random Read 360K IOPS\*
Random Write 330K IOPS\*

Self-Encrypting Drive

Support

\*Actual performance may vary.



### **Technical Specifications - Hard Drives**

HP Z Turbo Drv 2TB TLC PCIe SED OPAL2 (Z2G5)

Capacity 2TB Protocol PCle

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 600TBW (TB Written)

Reliability (MTBF) 1.5M Hours

Interface PCI Express 3.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3000MB/s\*

OPAL2

Sequential Write 2100MB/s\*
Random Read 320K IOPS\*
Random Write 265K IOPS\*

**Self-Encrypting Drive** 

Support

\*Actual performance may vary.

### **Technical Specifications - Graphics**

AMD Radeon™ Pro WX 3200 4GB Graphics Form Factor Mobile PCI Express Custom Module

Power 35W

**Bus Type** PCI Express 3.0 x8

Memory 4GB GDDR5

**Connectors** 3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

Maximum Resolution 4096x2160 x 24 bpp @ 60Hz

**Supported Graphics APIs** DirectX®12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

**Available Graphics** 

**Drivers** 

Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

 $\label{eq:heaviside} \mbox{HP qualified drivers may be preloaded or available from the HP support}$ 

Web site:

http://welcome.hp.com/country/us/en/support.html

Nvidia® Quadro® P620 4GB Graphics **Form Factor** Mobile PCI Express Custom Module

Power 35W

**Bus Type** PCI Express 3.0 x16

Memory 4GB GDDR5

**Connectors** 3x DisplayPort™ 1.2 – HDR ready connectors with HBR2 and MST support.

Maximum Resolution 4096x2160 x 24 bpp @ 60Hz

**Supported Graphics APIs** DirectX®12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

**Available Graphics** 

**Drivers** 

Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Nvidia® Quadro® T1000 4GB Graphics Form Factor Mobile PCI Express Custom Module

Power 50W

Bus Type PCI Express 3.0 x16

Memory 4GB GDDR6

**Connectors** 3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

Maximum Resolution 5120 x 3200 @ 60Hz

Supported Graphics APIs DirectX®12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0



### **Technical Specifications - Graphics**

**Available Graphics** 

Windows 10 64-bit

**Drivers** 

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Nvidia<sup>®</sup> Quadro<sup>®</sup> T2000 4GB Graphics **Form Factor** Mobile PCI Express Custom Module

Power 60W

**Bus Type** PCI Express 3.0 x16

Memory 4GB GDDR6

**Connectors** 3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

**Maximum Resolution** 5120 x 3200 @ 60Hz

Supported Graphics APIs DirectX®12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

**Available Graphics** 

Drivers

Windows 10 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Nvidia® Quadro® RTX 3000 6GB Graphics Form Factor Mobile PCI Express Custom Module

Power 60W

**Bus Type** PCI Express 3.0 x16

Memory 6GB GDDR6

**Connectors** 3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

Maximum Resolution 5120 x 3200 @ 60Hz\*

\*Requires 2 DisplayPorts™ to be plugged into a 5K monitor.

Supported Graphics APIs DirectX®12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

**Available Graphics** 

Windows 10 64-bit

**Drivers** 

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html



### Technical Specifications - Networking and Communications

Integrated Intel® I219LM Connector **PCIe GbE Controller** (Intel® vPro™ with Intel® **AMT 12.0)** 

**RJ-45** 

Controller Intel® I219LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

**Data Rates Supported** 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u,

802.3z

**Bus Architecture** PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

Requires 3.3V (integrated regulators for core Vdc) **Power Requirement** 

**Boot ROM Support** Yes

**Network Transfer Mode** Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

**Network Transfer Rate** 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro™, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI,

Advanced cable diagnostic, loopback modes.

AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery

(MLD)

Intel® 9560 Wireless LAN Connector (802.11ac) and Bluetooth Controller 5 Module

Compliance

M.2 (Supports 2230 form factor; E Key) Motherboard Interface

Intel® Dual Band Wireless-AC 9560

Wireless LAN: IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i,

802.11h, 802.11w, CCX 4.x/CCX Lite, WMM, WPA, WPA2, APS, WPS 2.0,

**Protected Management Frames** 

Bluetooth®: Dual Mode Bluetooth® 2.1, 2.1+EDR, 3.0, 4.0, BLE, 4.2, and 5

**Bus Architecture** PCI Express Gen3 x1 and USB 2.0 **Power Requirement** Requires 3.3V; 1.65W TDP

Management Capabilities Wake on WLAN (in all sleep states, excluding Max Power Savings mode),

WFA Management Frame Protection (802.11w), vPro™/WiAMT Not Currently Supported, F10 BIOS Menu option to disable/enable WLAN and Bluetooth® radios, supports seamless roaming between 802.11 wireless

access points

Max PHY throughput 1.73 Gbps (802.11ac) for WLAN Throughput

**Allied Telesis 1GbE LC** Fiber 2pc Module

Network Interface(s)

1 LC Fiber Connection

**System Interface Network Cable** 

PCI Express Gen1.1x1 (via WLAN M.2 interface)

1GbE over Multimode LC Fiber. Distance is dependent upon network cable:

OM1 50/125um 500 MHz:km 550m OM2 62.5/125um 200 MHz:km 275m OM2 62.5/125um 160MHz:km 220m



### Technical Specifications - Networking and Communications

**Data Rates Supported** 1 Gbps

**LED Indicators** Link/Activity LED (Green): Off = No Link, Solid = Link, Blinking = Activity

Controller Broadcom BCM57762
Compliance IEE 802.3z Base1000SX

802.3x (Ethernet Flow Control)

802.1Q (VLANs)

802.1P (Quality of Service)

FCC B (USA)

CE (European Union) ICES-003 B (Canada) BSMI (Taiwan) VCCI (Japan) KCC (Korea)

CTICK (Australia/New Zealand)

**UL** (Safety)

**RoHS (Restricted or Hazardous Substances)** 

**Power Requirement** 2W (Typical)

**Operating Temperature** 32° to 122° F (0° to 50° C)

**Physical Dimensions** 

(LxW)

LC Fiber Board: 37mm x 45mm x 13mm (WxLxH, including connector)

Cable: 200mm

M.2 Board: 22mm x 30mm x 1.75mm (WxLxH)

**Kit Contents** LC fiber board, M.2 board, connecting cable, and 2 screws for attaching the

LC fiber board to the motherboard

Product Warranty statement and the Installation Guide.



### Technical Specifications – Miscellaneous Features

#### **MISCELLANEOUS FEATURES**

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
   Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### **Serviceability Features**

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
    - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically)
    - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy + 3 white User must enter a key sequence to proceed with recovery by policy + 3 white User must enter a key sequence to proceed with recovery by policy
    - 2 red + 4 white BIOS recovery is in progress + 4 white BIOS recovery is in progress + 4 white BIOS recovery is in progress
    - 3 red + 2 white Memory could not be initialized + 2 white Memory could not be initialized + 2 white Memory could not be initialized
    - 3 red + 3 white Graphics adaptor could not be found + 3 white Graphics adaptor could not be found +
       3 white Graphics adaptor could not be found
    - 3 red + 4 white Power supply failure / not connected + 4 white Power supply failure / not connected +
       4 white Power supply failure / not connected
    - 3 red + 5 white Processor not installed + 5 white Processor not installed + 5 white Processor not installed
    - 3 red + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature
    - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
    - 4 red + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold
    - 5 red + 2 white System controller firmware is not valid
    - 5 red + 3 white System controller detected BIOS is not executing
    - 5 red + 4 white BIOS could not complete initialization / PCA failure
    - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)



### Technical Specifications – Miscellaneous Features

- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



## **Summary of Changes**

Date of change:	Version History:	Description of change:
	From v1 to v2	



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